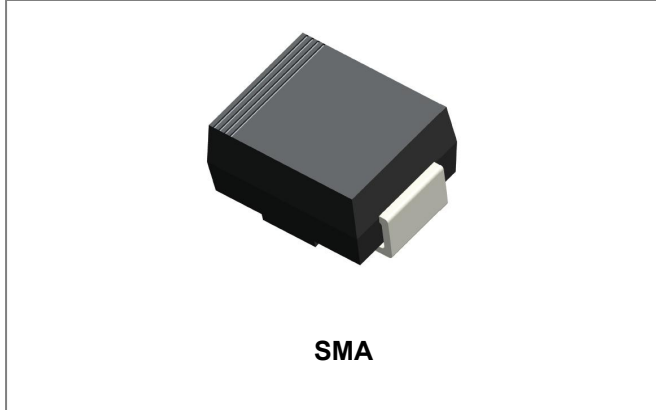


SL12 THRU SL14 LOW VF SURFACE MOUNTSCHOTTKY RECTIFIER



Features

- Schottky Barrier Chip
- Very low forward voltage drop
- Guard Ring Die Construction for Transient Protection
- High Current Capability
- Low Power Loss, High Efficiency
- High Surge Current Capability
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Terminals finish: Tin Lead-free plated
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

- Case: Low Profile Molded plastic
- Terminals: Plated leads solderable per MIL-STD-750, Method 2026
- Polarity: Color band or cathode Notch
- Mounting Position: Any
- Weight: 0.06grams(approx)

Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	SL12	SL13	SL14	Units
Peak Repetitive Reverse Voltage	V_{RRM}				
Working Peak Reverse Voltage	V_{RWM}	20	30	40	V
DC Blocking Voltage	V_R				
Maximum RMS voltage	V_{RMS}	14	21	28	V
Average Rectified Output Current @ $T_L=75^\circ\text{C}$	I_o	1.0			A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	30			A
Forward Voltage @ $I_o=1.0\text{ A}$	V_F	0.38		0.40	V
Peak Reverse Current @ $T_A=25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_A=100^\circ\text{C}$	I_{RM}	0.5 20			mA
Typical Thermal Resistance Junction to Ambient (Note 1)	$R_{\theta JA}$	75			K/W
Operating Temperature Range	T_J	-65 to +125			$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-65 to +150			$^\circ\text{C}$

Note: 1. mounted on P.C. Board with 5.0mm² copper pad areas.

- China - Germany - Korea - Singapore - United States •
- <http://www.smc-diodes.com> - sales@smc-diodes.com •

Ratings and Characteristics Curves

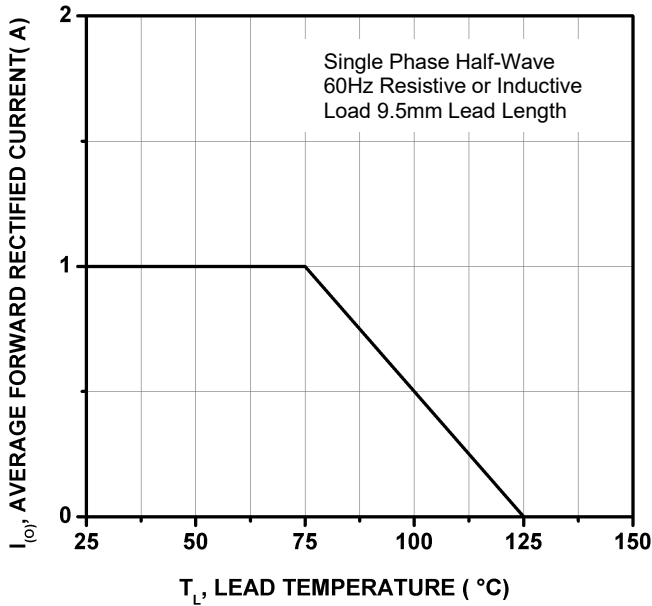


Fig.1 Forward Current Derating Curve

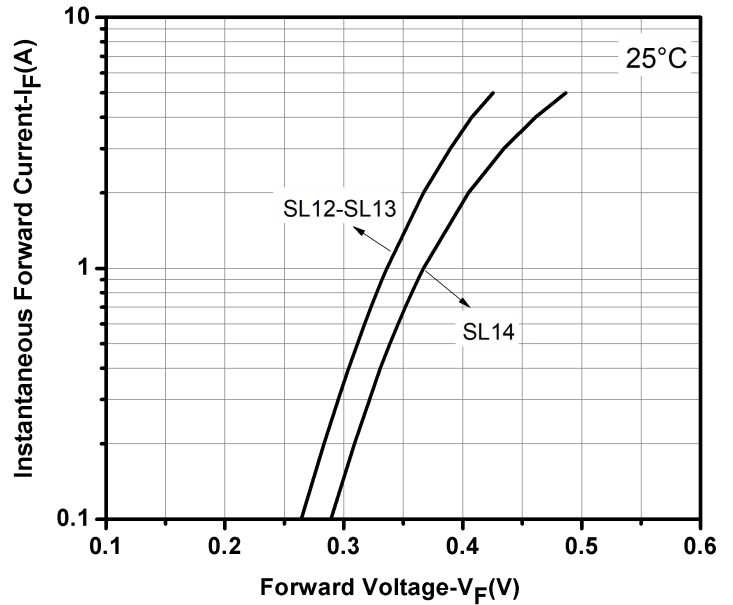


Fig.2 Typical Forward Characteristics

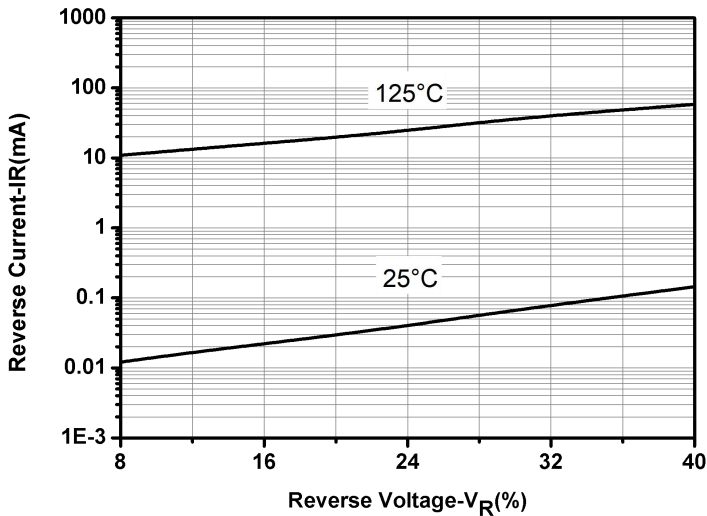


Fig.3 Typical Reverse Characteristics

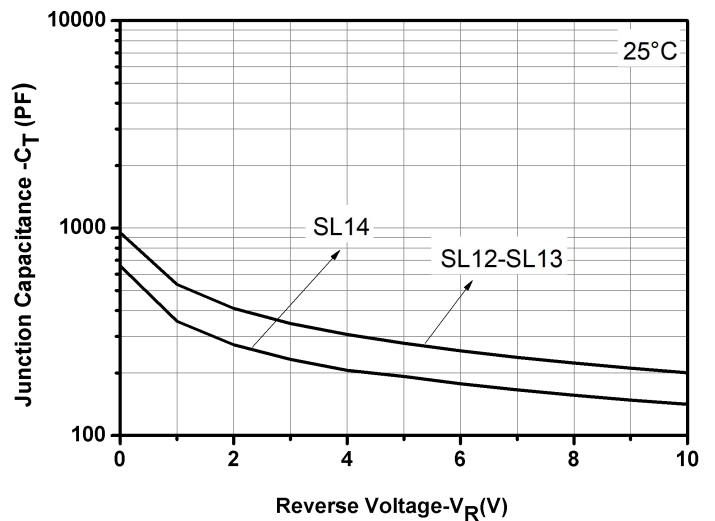
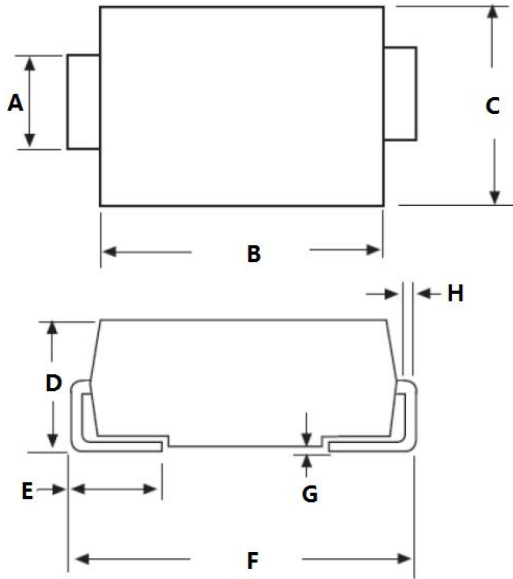


Fig.4 Typical Junction Capacitance

Mechanical Dimensions SMA



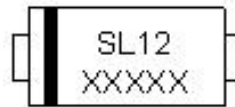
SYMBOL	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.25	1.65	0.049	0.065
B	3.95	4.6	0.156	0.181
C	2.25	2.95	0.089	0.116
D	1.95	2.9	0.077	0.114
E	0.75	1.6	0.03	0.063
F	4.8	5.6	0.189	0.22
G	0.05	0.2	0.002	0.008
H	0.15	0.41	0.006	0.016

Ordering Information

Device	Package	Shipping
SL12 - SL14	SMA (Pb-Free)	5000pcs / reel
SL12TR - SL14TR	SMA (Pb-Free)	5000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram

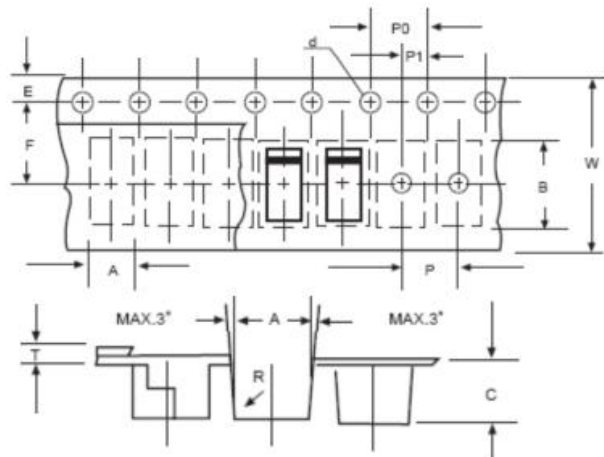


Where XXXXX is YYWWL

SL12 = Part Name
YY = Year
WW = Week
L = Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

Carrier Tape Specification SMA



SYMBOL	Millimeters	
	Min.	Max.
A	2.97	3.17
B	5.70	5.90
C	2.32	2.52
d	1.40	1.60
E	1.40	1.60
F	5.60	5.70
P	3.90	4.10
P0	3.90	4.10
P1	1.90	2.10
T	0.25	0.35
W	11.80	12.20

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